Characteristics STPSC20H065C

#### 1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C unless otherwise specified)

Symbol	Para	Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage	650	V	
I <sub>F(RMS)</sub>	Forward rms current		22	Α
1	Average forward current	$T_c = 135  ^{\circ}C^{(1)}$ , DC, per diode	10	۸
I <sub>F(AV)</sub>	Average forward current	T <sub>c</sub> = 125 °C <sup>(2)</sup> , per device	20	Α
	Curae non repetitive femuera	$t_p = 10$ ms sinusoidal, $T_c = 25$ °C	90	
I <sub>FSM</sub>	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal, } T_c = 125 ^{\circ}\text{C}$	80	Α
	Current	$t_p = 10 \mu s square, T_c = 25 °C$	470	
I <sub>FRM</sub>	Repetitive peak forward current	$T_c = 135 \text{ °C}^{(1)}, T_j = 175 \text{ °C}, \delta = 0.1$	36	Α
T <sub>stg</sub>	Storage temperature range	-55 to +175	°C	
Tj	Operating junction temperature <sup>(3)</sup>	-40 to +175	°C	

<sup>1.</sup> Value based on  $R_{th(j-c)}$  max (per diode)

Table 3. Thermal resistance

Symbol	Parameter			Value		Unit
Symbol	Fai	Тур.	Max.	Oiiit		
R <sub>th(j-c)</sub>	Junction to case per diode	Per diode	TO-247	1.25	1.5	
			TO-220AB			
		Total	TO-247	0.83	0.95	°C/W
		Total	TO-220AB	0.03		
R <sub>th(c)</sub>	Coupling				0.4	

When the two diodes 1 and 2 are used simultaneously:

 $\Delta T_i$ (diode 1) = P(diode 1) x R<sub>th(j-c)</sub>(Per diode) + P(diode 2) x R<sub>th(c)</sub>

Table 4. Static electrical characteristics per diode

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
<sub>I_</sub> (1)	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	$V_R = V_{RRM}$	-	9	100	μΑ
'R`′		T <sub>j</sub> = 150 °C		-	85	425	
V <sub>E</sub> (2)	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 10 A	-	1.56	1.75	V
VF`'	Forward voltage drop	T <sub>j</sub> = 150 °C		-	1.98	2.5	<b>V</b>

<sup>1.</sup>  $t_p = 10 \text{ ms}, \delta < 2\%$ 

To evaluate the conduction losses use the following equation:

$$P = 1.35 \times I_{F(AV)} + 0.115 \times I_{F^{2}(RMS)}$$

5/

2/9 DocID023605 Rev 3

<sup>2.</sup> Value based on  $R_{\text{th(j-c)}}$  max (per device)

<sup>3.</sup>  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

<sup>2.</sup>  $t_p = 500 \ \mu s, \ \delta < 2\%$ 

STPSC20H065C Characteristics

Table 5. Dynamic electrical characteristics per diode

Symbol	Parameter	Test conditions	Тур.	Unit
Q <sub>cj</sub> <sup>(1)</sup>	Total capacitive charge	V <sub>R</sub> = 400 V	28.5	nC
C	Total capacitance	$V_R = 0 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ MHz}$	480	pF
C <sub>j</sub>	Total Capacitance	$V_R = 400 \text{ V}, T_c = 25 \text{ °C}, F = 1 \text{ MHz}$	48	pΓ

<sup>1.</sup> Most accurate value for the capacitive charge:  $Q_{cj} = \int_{1}^{V_{OUT}} c_j(v_R).dv_R$ 

Figure 1. Forward voltage drop versus forward Figure current (typical values per diode, low level) curre

| F<sub>M</sub>(A) | Pulse test : t<sub>p</sub>=500µs | T<sub>a</sub>=25 °C | T<sub>a</sub>=150 °C | T<sub>a</sub>=175 °C | Results of the set o

Figure 2. Forward voltage drop versus forward current (typical values per diode, high level)

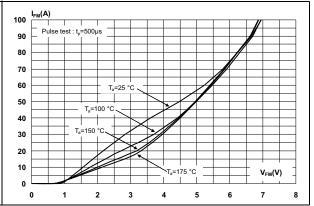
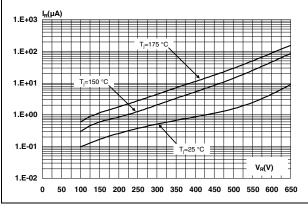
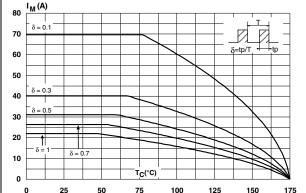


Figure 3. Reverse leakage current versus reverse voltage applied (typical values per diode)

Figure 4. Peak forward current versus case temperature, per diode

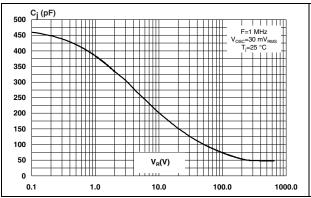




Characteristics STPSC20H065C

Figure 5. Junction capacitance versus reverse voltage applied (typical values, per diode)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration per diode



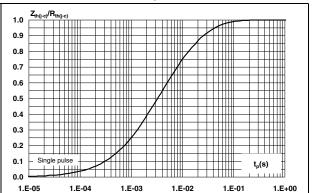
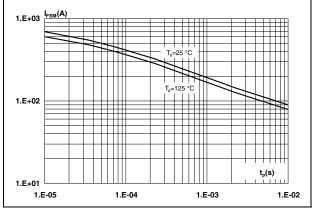
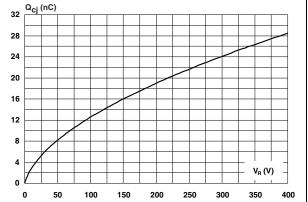


Figure 7. Non-repetitive peak surge forward current versus pulse duration per diode (sinusoidal waveform)

Figure 8. Total capacitive charges versus reverse voltage applied (typical values per diode)





### 2 Package information

- Epoxy meets UL94, V0
- Cooling method: conduction (C)
- · Recommended torque value:
  - TO-220AB 0.4 to 0.6 N⋅m,
  - TO-247 0.55 N⋅m (1.0 N⋅m maximum)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

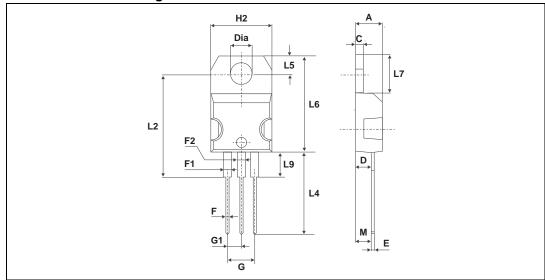


Figure 9. TO-220AB dimension definitions



Package information STPSC20H065C

Table 6. TO-220AB dimension values

	Dimensions						
Ref.	Millim	neters	Inch	nes			
	Min.	Max.	Min.	Max.			
А	4.40	4.60	0.173	0.181			
С	1.23	1.32	0.048	0.051			
D	2.40	2.72	0.094	0.107			
Е	0.49	0.70	0.019	0.027			
F	0.61	0.88	0.024	0.034			
F1	1.14	1.70	0.044	0.066			
F2	1.14	1.70	0.044	0.066			
G	4.95	5.15	0.194	0.202			
G1	2.40	2.70	0.094	0.106			
H2	10	10.40	0.393	0.409			
L2	16.4	typ.	0.645 typ.				
L4	13	14	0.511	0.551			
L5	2.65	2.95	0.104	0.116			
L6	15.25	15.75	0.600	0.620			
L7	6.20	6.60	0.244	0.259			
L9	3.50	3.93	0.137	0.154			
М	2.6 typ.		0.102 typ.				
Diam.	3.75	3.85	0.147	0.151			

STPSC20H065C Package information

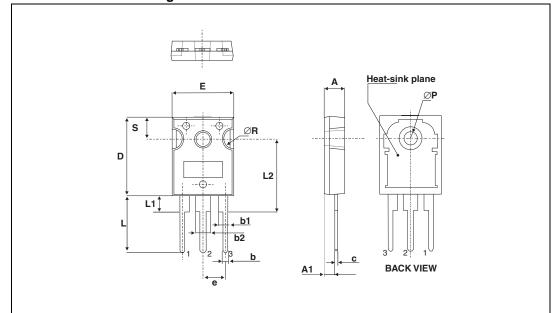


Figure 10. TO-247 dimension definitions

Table 7. TO-247 dimension values

	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур	Max.	
А	4.85		5.15	0.191		0.203	
A1	2.20		2.60	0.086		0.102	
b	1.00		1.40	0.039		0.055	
b1	2.00		2.40	0.078		0.094	
b2	3.00		3.40	0.118		0.133	
С	0.40		0.80	0.015		0.031	
D <sup>(1)</sup>	19.85		20.15	0.781		0.793	
Е	15.45		15.75	0.608		0.620	
е	5.30	5.45	5.60	0.209	0.215	0.220	
L	14.20		14.80	0.559		0.582	
L1	3.70		4.30	0.145		0.169	
L2		18.50 typ.					
ØP <sup>(2)</sup>	3.55		3.65	0.139		0.143	
ØR	4.50		5.50	0.177		0.217	
S	5.30	5.50	5.70	0.209	0.216	0.224	

<sup>1.</sup> Dimension D plus gate protrusion does not exceed 20.5 mm

<sup>2.</sup> Resin thickness around the mounting hole is not less than 0.9 mm



Ordering information STPSC20H065C

# 3 Ordering information

**Table 8. Ordering information** 

Order code Marking		Package	Weight	Base qty	Delivery mode
STPSC20H065CT	STPSC20H065C	TO-220AB	1.86 g	50	Tube
STPSC20H065CW STPSC20H065CW		TO-247	4.43 g	30	Tube

# 4 Revision history

**Table 9. Document revision history** 

Date	Revision	Changes
31-Aug-2012	1	First issue.
10-Oct-2012	2	Added Max. values to <i>Table 3</i> .
07-Nov-2013	3	Updated Figure 1 and Figure 2.

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DocID023605 Rev 3

9/9